

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT								
NATURE OF CONVEYANCE:	Corrective Assignment to correct the name of the Assignee from Hitachi Hi-Technologies Corporation to Hitachi High-Technologies Corporation previously recorded on Reel 014399 Frame 0278. Assignor(s) hereby confirms the name of the Assignee is Hitachi High-Technologies Corporation.								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Toshifumi Honda</td><td>07/16/2003</td></tr><tr><td>Hirohito Okuda</td><td>07/18/2003</td></tr></tbody></table>		Name	Execution Date	Toshifumi Honda	07/16/2003	Hirohito Okuda	07/18/2003		
Name	Execution Date								
Toshifumi Honda	07/16/2003								
Hirohito Okuda	07/18/2003								
RECEIVING PARTY DATA									
<table border="1"><tr><td>Name:</td><td>Hitachi High-Technologies Corporation</td></tr><tr><td>Street Address:</td><td>24-14, Nishishinbashi 1-chome, Minato-ku</td></tr><tr><td>City:</td><td>Tokyo</td></tr><tr><td>State/Country:</td><td>JAPAN</td></tr></table>		Name:	Hitachi High-Technologies Corporation	Street Address:	24-14, Nishishinbashi 1-chome, Minato-ku	City:	Tokyo	State/Country:	JAPAN
Name:	Hitachi High-Technologies Corporation								
Street Address:	24-14, Nishishinbashi 1-chome, Minato-ku								
City:	Tokyo								
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PROPERTY NUMBERS Total: 1									
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>10640343</td></tr></tbody></table>		Property Type	Number	Application Number:	10640343				
Property Type	Number								
Application Number:	10640343								
CORRESPONDENCE DATA									
Fax Number: (415)576-0300 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
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ATTORNEY DOCKET NUMBER:	16869P-078200US								
NAME OF SUBMITTER:	Jason A. Sanders								
Total Attachments: 4									

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PATENT
REEL: 019415 FRAME: 0446

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Attorney Docket No. 16869P-078200US

Form PTO-1595

(Rev. 10-02)

OMB No. 0651-0027 (exp. 5/31/2002)



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U.S. Department of Commerce
U.S. Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof

1. Name of conveying party(ies):

Toshifumi Honda
Hirohito OkudaAdditional name(s) of conveying party(ies) attached? ☐ Yes ☒ No.

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other:

Execution Date: July 16, 2003 and July 18, 2003

2. Name and address of receiving party(ies)

Name: Hitachi Hi-Technologies Corporation

Street Address: 24-14, Nishishinbashi 1-chome, Minato-ku

City: Tokyo

Country: Japan

Additional name(s) and address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: July 16, 2003 and July 18, 2003

A. Patent Application No(s):

B. Patent No(s):

Additional numbers attached? ☐ Yes ☐ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Chun-Pok Leung
TOWNSEND AND TOWNSEND AND CREW LLP
Two Embarcadero Center, 8th Floor
San Francisco, California 94111-3834
(415) 576-0200

6. Total number of applications and patents involved 1

7. Total fee (37 CFR 3.41): _____ \$40.00

☐ Enclosed☒ Authorized to be charged to deposit account8. Deposit account number: **20-1430**

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*Chun-Pok Leung
Name of Person Signing
Atty. Reg. No. 41,405
Signature8-12-03
Date

Total number of pages including cover sheet, attachments and documents: 2

Mail documents to be recorded with required cover sheet information to:

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PATENT
REEL: 019415 FRAME: 0448

ASSIGNMENT
(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan, located at 24-14, Nishishinbashi 1-chome, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

DEFECT INSPECTION METHOD

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi High-Technologies Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1) <u>Toshiki Ikenaga</u>	<u>July 16, 2003</u>
2) <u>Hiroko Otuda</u>	<u>July 18, 2003</u>
3) _____	_____
4) _____	_____
5) _____	_____
6) _____	_____
7) _____	_____
8) _____	_____
9) _____	_____
10) _____	_____

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